

## PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT						
NATURE OF CONVEYANCE:	ASSIGNMENT						
CONVEYING PARTY DATA							
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Steven ZHANG</td> <td>06/13/2013</td> </tr> <tr> <td>Liya FU</td> <td>06/13/2013</td> </tr> </tbody> </table>		Name	Execution Date	Steven ZHANG	06/13/2013	Liya FU	06/13/2013
Name	Execution Date						
Steven ZHANG	06/13/2013						
Liya FU	06/13/2013						
RECEIVING PARTY DATA							
Name:	SEMICONDUCTOR MANUFACTURING INTERNATIONAL CORPORATION (SHANGHAI)						
Street Address:	NO. 18 ZHANGJIANG ROAD						
Internal Address:	PUDONG NEW AREA						
City:	SHANGHAI						
State/Country:	CHINA						
Postal Code:	201203						
PROPERTY NUMBERS Total: 1							
<table border="1"> <thead> <tr> <th>Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>13927830</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	13927830		
Property Type	Number						
Application Number:	13927830						
CORRESPONDENCE DATA							
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Signature:	/Signe Holmbeck/						

OP \$40.00 13927830

Date:

06/26/2013

Total Attachments: 2

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### ASSIGNMENT

For good and valuable consideration, receipt of which is hereby acknowledged, we

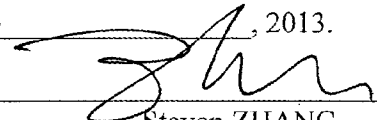
Steven ZHANG of No. 18 Zhangjiang Road, Pudong New Area Shanghai, P.R.C. 201203  
Liya FU of No. 18 Zhangjiang Road, Pudong New Area Shanghai, P.R.C. 201203

hereby sell, assign and transfer to **Semiconductor Manufacturing International Corporation**, having a place of business at No. 18 Zhangjiang Road, Pudong New Area, Shanghai, P.R.C. 201203, its successors and assigns, the entire right, title and interest throughout the world in our invention in

### SEMICONDUCTOR DEVICE AND FABRICATING METHOD THEREOF

for which we have executed a United States patent application on or about the date of this assignment, and all patent applications and patents of every country for said invention, including divisionals, reissues, continuations and extensions thereof, and all rights of priority resulting from the filing of said applications; we authorize the above-named assignee to apply for patents of foreign countries for said invention, and to claim all rights of priority without further authorization from us; we agree to execute all papers useful in connection with said United States and foreign applications, and generally to do everything possible to aid said assignee, its successors, assigns and nominees, at their request and expense, in obtaining and enforcing patents for said invention in all countries; and we request that the United States Patent and Trademark Office issue all patents granted for said invention to the above-named assignee, its successors and assigns.

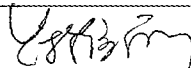
Executed this 13 day of June, 2013.

  
\_\_\_\_\_  
Steven ZHANG

WITNESSED: Dongfang Wang  
Signature \_\_\_\_\_  
Dongfang Wang  
Date \_\_\_\_\_  
2013-6-14  
Type or print name of witness \_\_\_\_\_

Attorney Docket No.: SMIC00057 US  
Client Reference No.: 2012-00823-SH-US

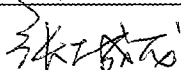
Executed this 13 day of June, 2013.



Liya FU

WITNESSED:

Signature



Date

2013-6-14

Type or print name of witness